

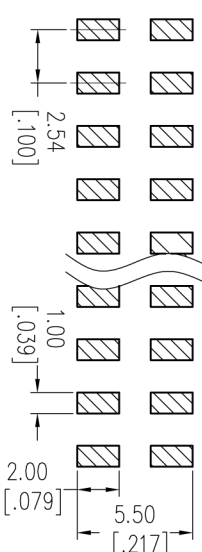
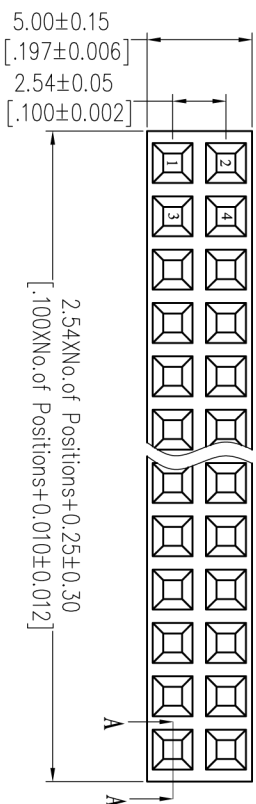
HSP

NOTES:

Current Rating: 3.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 1000V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze Or Brass
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

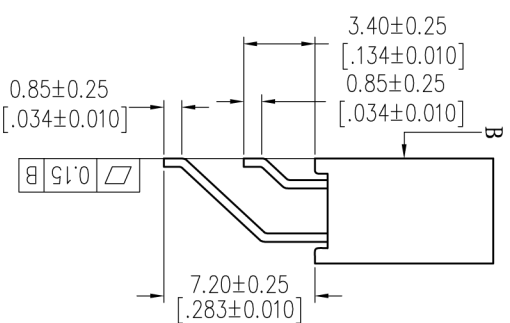
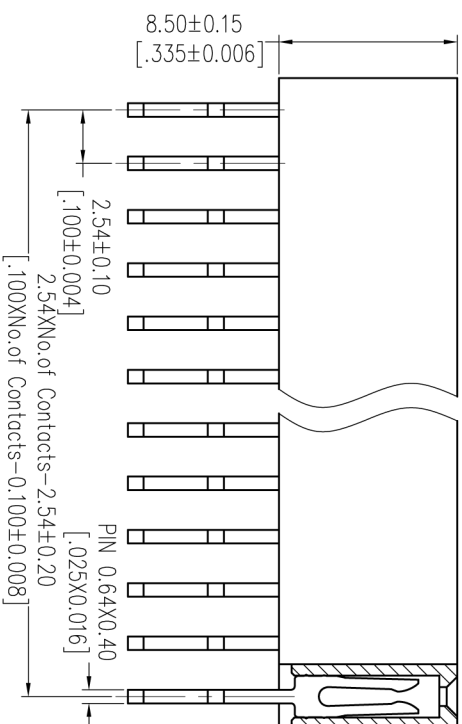
2185 - 2 XX Z XX C Y N T 1

No. of Pins per ROW: 52-40PIN

Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Mate Tin

Packing:
 T=Tube
 R=Tube&Reel

Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		



OPERATION		DRAW		DATE		SCALE		PART NO.		
XX	±0.40	JYhuang		2012/08/15		mm		2185-2XXZXXCYNTX		
XX	±0.25	CHECK		DATE		A4		TITLE:		
X	±0.15	ANGLE	± 3'	DATE		1/1		PH: 2.54mm DUAL ROW 90° SMT H=8.50		
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL	APPROVE	DATE	PROJ.	Customer NO.
A0	2012/08/15	NEW								

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